

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Mail Stop Patent Application
 Commissioner for Patents
 P.O. Box 1450
 Alexandria, VA 22313-1450



Re: Inventors: Norman Shendon, Michael T. Sherwood and Harry Lee,
 Title: FLUID-PRESSURE REGULATED WAFER POLISHING HEAD

Transmitted herewith is the patent application identified above, including:

- ☒ Specification, claims and abstract, totaling (15) pages.
- ☒ Formal Drawings totaling (3) pages.
- ☒ Copy of Executed Declaration and Power of Attorney from parent application (3) pages.

This application is a continuation of U.S. Application Serial No. 10/201,428, which is a continuation of U.S. Application Serial No. 09/892,143, filed June 25, 2001, which is a continuation of U.S. Application Serial No. 09/406,027, filed September 27, 1999, now U.S. Patent No. 6,290,577, which is a continuation of U.S. Application Serial No. 08/488,927, filed June 9, 1995, now U.S. Patent No. 6,024,630, each of which are incorporated herein by reference in their entirety.

FEE CALCULATION

Fee Items	Claims Filed	Included With Basic Fee	Extra Claims	Fee Rate	Total
Total Claims	20	- 20 =	0	X \$18.00	<u>\$0.00</u>
Independent Claims	2	- 3 =	0	X \$84.00	<u>\$0.00</u>
Basic Filing Fee				\$ 750.00	\$750.00
TOTAL FEES					\$750.00

☒ The Commissioner is hereby authorized to charge \$750.00 to Deposit Account No. 50-1074.

☒ The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 50-1074. A duplicate copy of this transmittal is enclosed.

☒ Please address all future correspondence to:

PATENT COUNSEL
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I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope addressed to: Box Patent Application, Commissioner for Patents, Washington, D.C. 20231.

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Signature [Signature]

Respectfully submitted,

[Signature]
 Robert W. Mulcahy
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